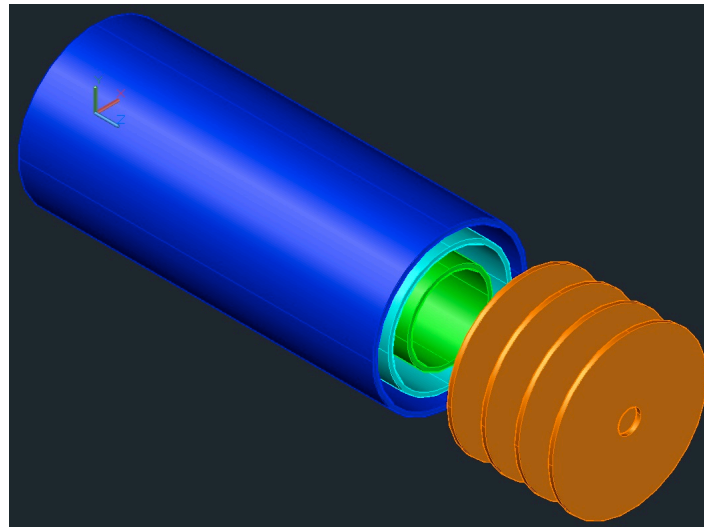


Design and Assembly of fast and light-weight **barrel** / **forward** prototype tracking detectors (EIC R&D)

PI Barrel System: Franck Sabatie (Saclay)

and

PI Forward System: Bernd Surrow (MIT / Temple Univ.)



Proposal

Design and assembly of fast and lightweight barrel and forward tracking prototype systems for an EIC

S. Aune, E. Delagnes , M. Garçon, I. Mandjavidze, S. Procureur, F. Sabatié¹
CEA Saclay - Irfu

B. Surrow²
MIT / Temple University

D. Hasell, R. Milner, B. Redwine, G. van Nieuwenhuizen
MIT, Laboratory for Nuclear Science

B. Buck, J. Bessuille
MIT, Bates Laboratory

Outline

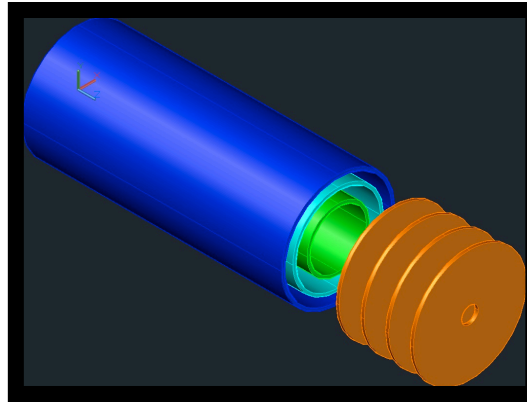
□ Introduction

□ **Micromegas Barrel System**

- Motivation
- CLAS12 experience
- R&D plan
- Institutional background

□ **Triple-GEM Forward System**

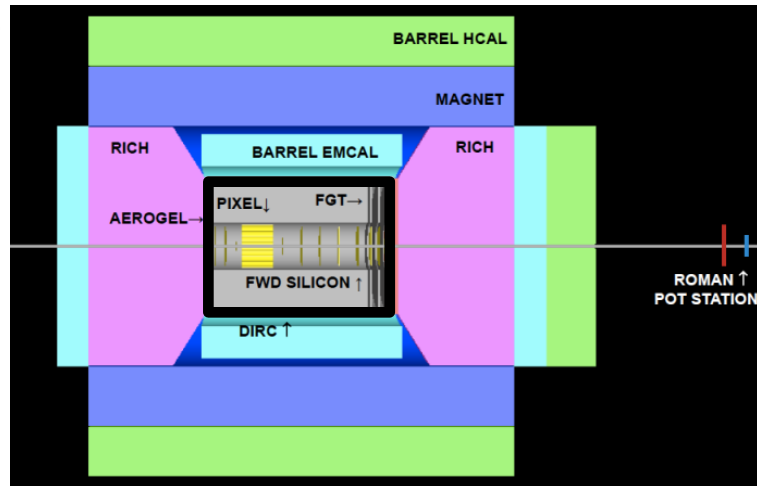
- Motivation
- STAR experience
- R&D plan
- Institutional background



□ Collaborative efforts

□ Research plan / Funding request

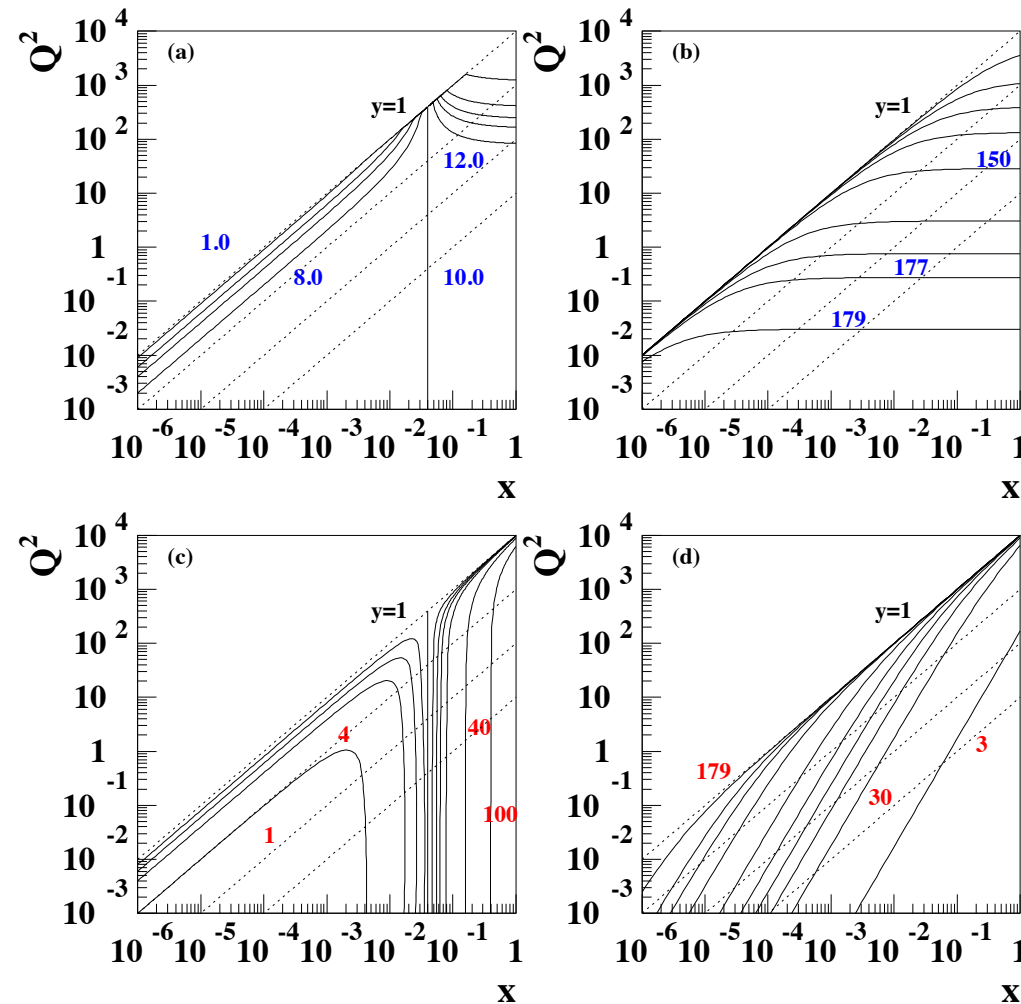
□ Summary



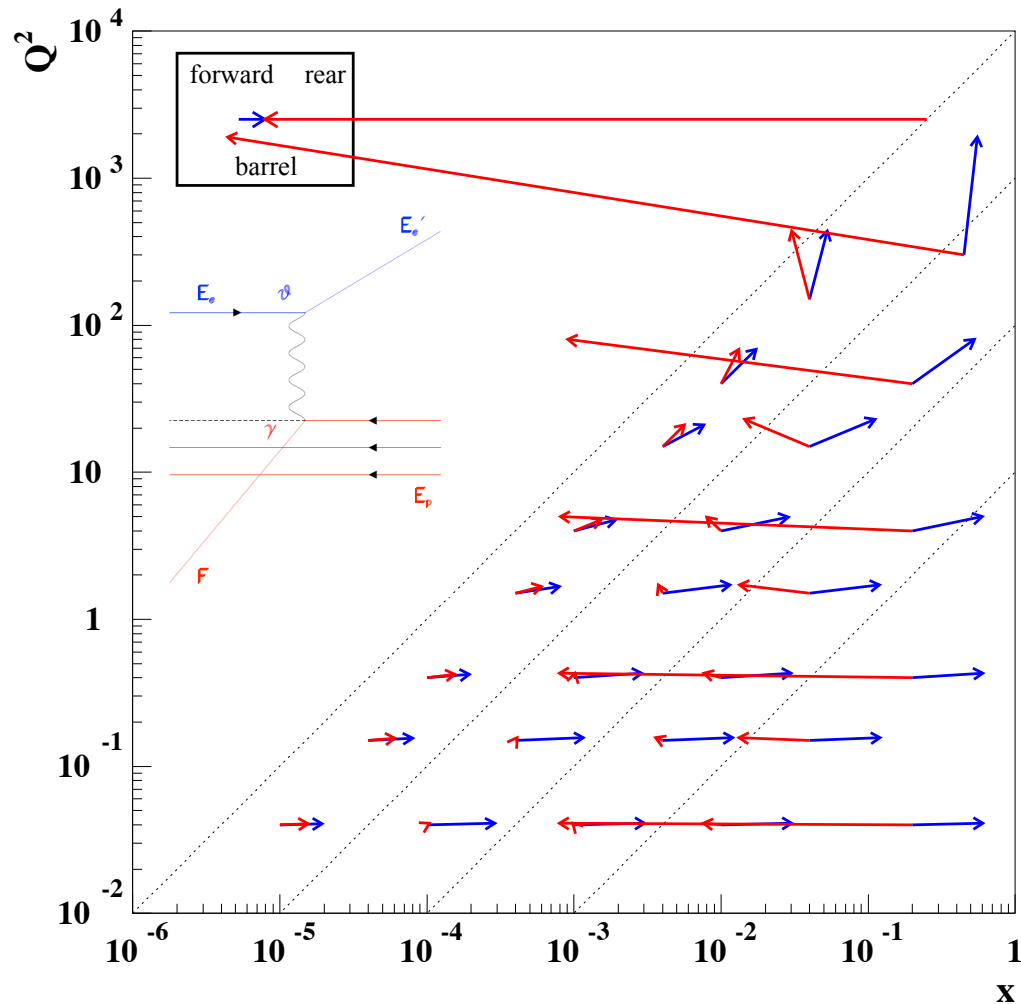
Introduction

□ Remarks on ep Collider Kinematics: 10GeV (e) X 250GeV (p)

EIC kinematics ($E_e=10$ GeV, $E_p=250$ GeV)



EIC event topology ($E_e=10$ GeV, $E_p=250$ GeV)

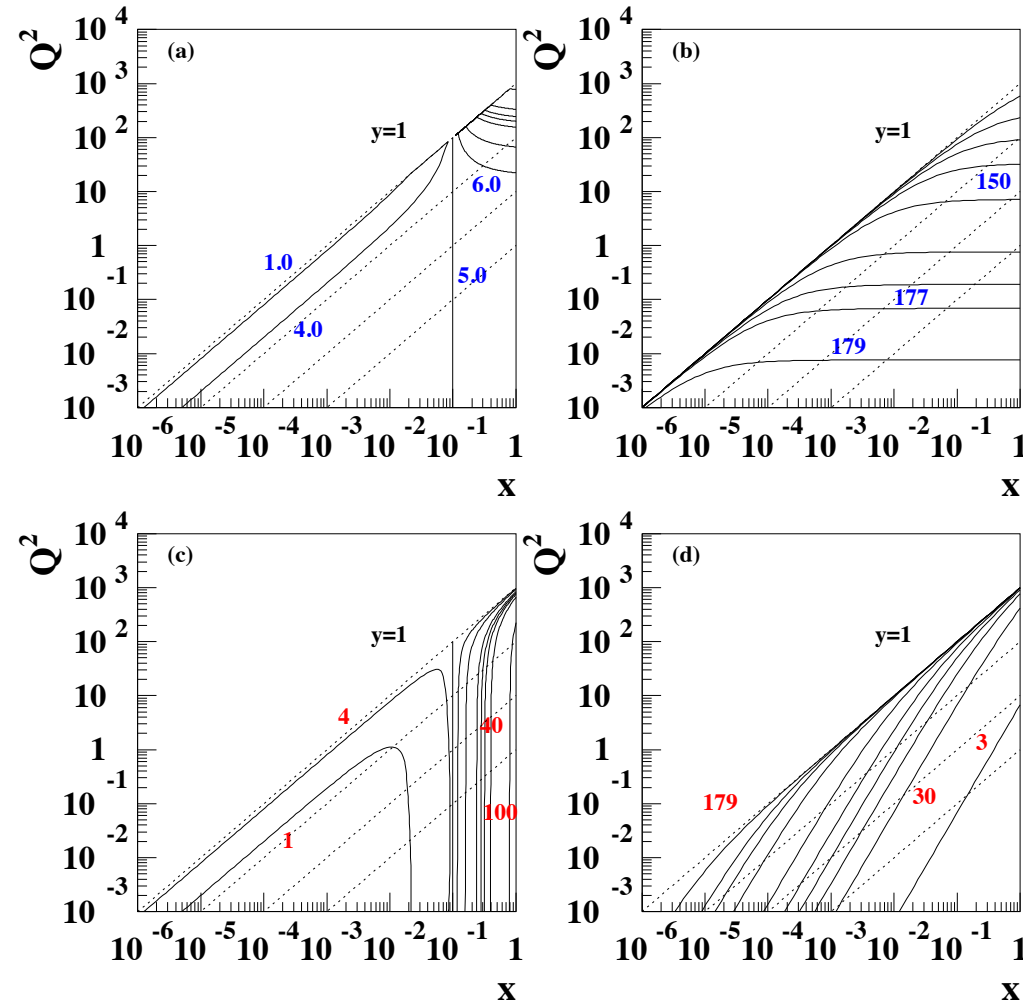


$$E_e/E_p = 0.04$$

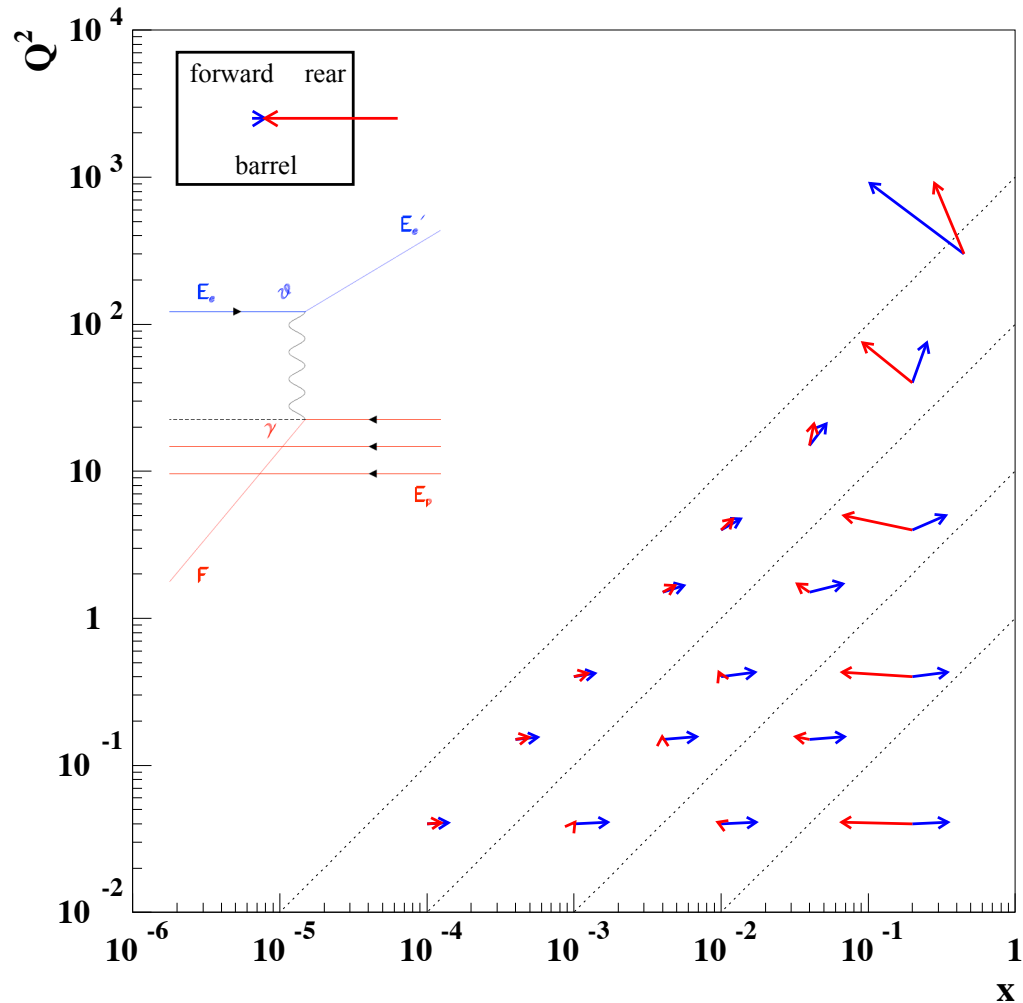
Introduction

Remarks on ep Collider Kinematics: 5GeV (e) X 50GeV

EIC kinematics ($E_e=5$ GeV, $E_p=50$ GeV)



EIC event topology ($E_e=5$ GeV, $E_p=50$ GeV)

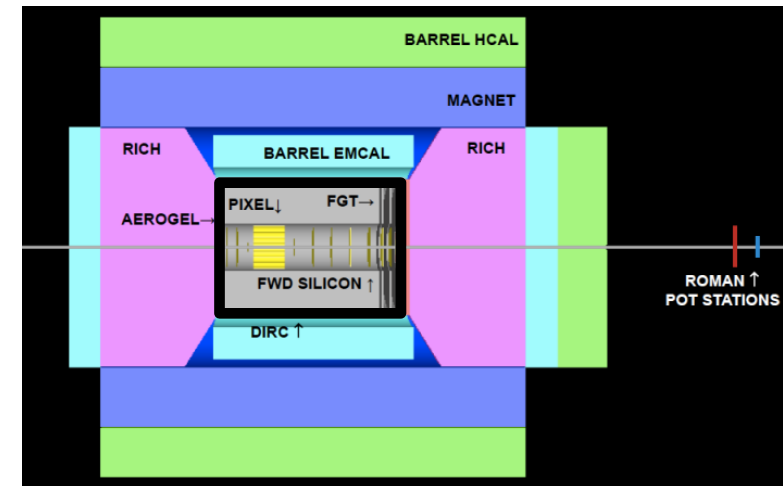
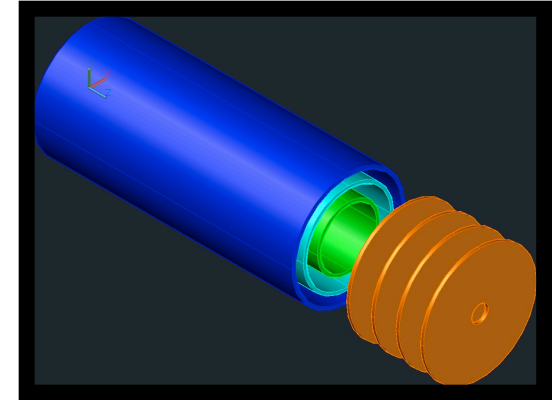


$$E_e/E_p = 0.1$$

Introduction

□ Considerations on Tracking System

- Tracking over **wide acceptance** range: **Forward with $\sim 1^\circ$** and **Rear with $\sim 179^\circ$** , excluding very forward/rear detector regions
- Contribute to **reconstruction of event kinematics** besides calorimetry in particular at very small energies
- **High-rate environment** ($\sim 10\text{MHz}$ ep collisions)
- **Fast time response**
- **Precision hit resolution**, e.g. low Q^2 region
- **Minimal dead material** ($\sim 1\% X_0$)
- **Cost effective solution** for large tracking detector areas
- Profit from world-wide **micro-pattern detector development** (RD51 Collaboration)

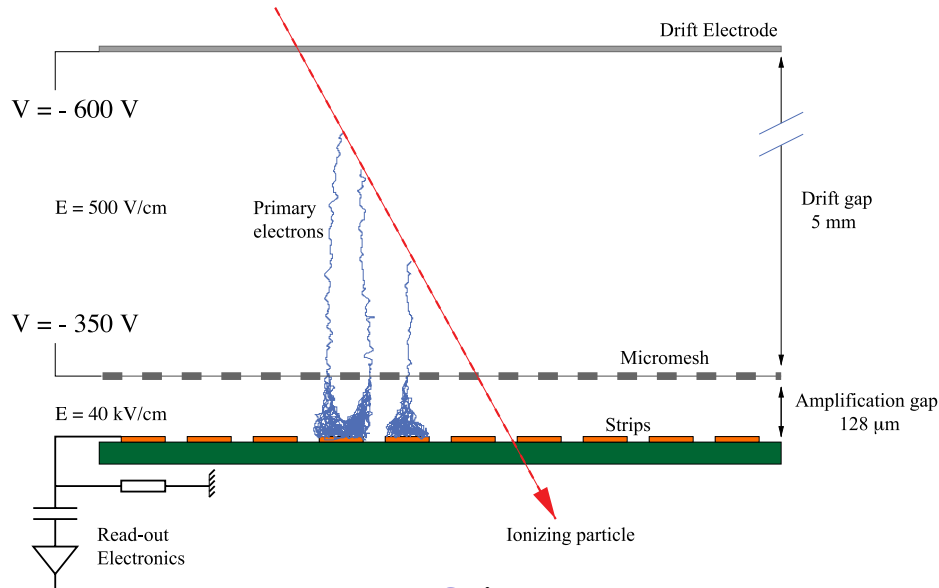


Introduction

□ Micro-pattern Tracking detector concepts

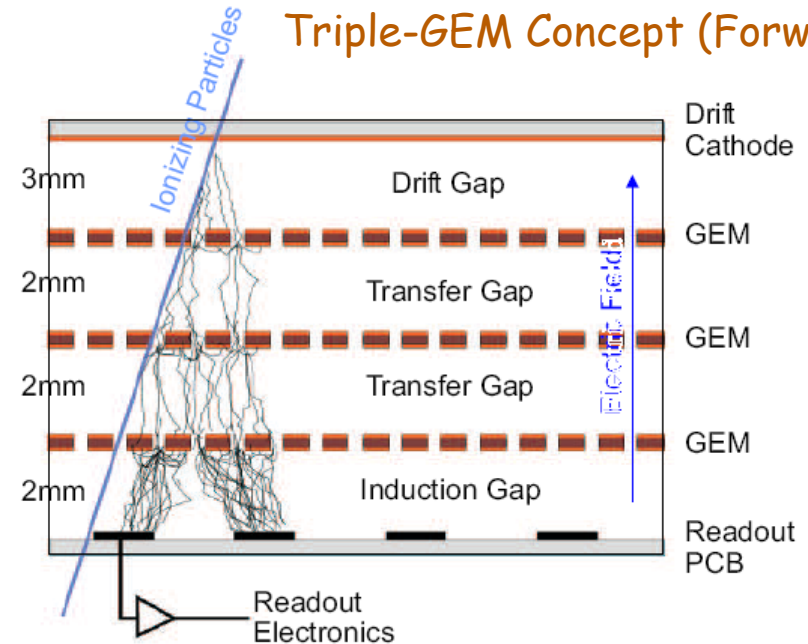
- Fast time response
- Separation of drift region from charge-collection region
- Flexibility in 2D readout structure (planar / cylindrical)
- Enormous progress in principal component production (GEM foil / Micromesh) including commercial fabrication
- Low dead material ($< 1\% X_0$)
- Relatively low material cost per unit area

Micromegas Concept (Barrel)



MICROMesh Gaseous Structure

Triple-GEM Concept (Forward)



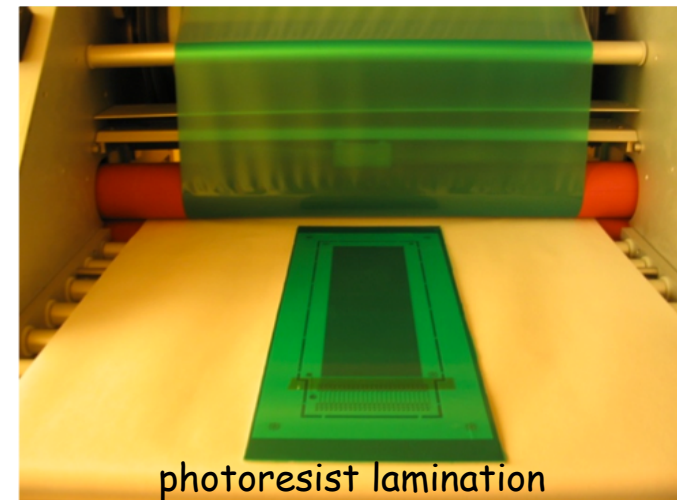
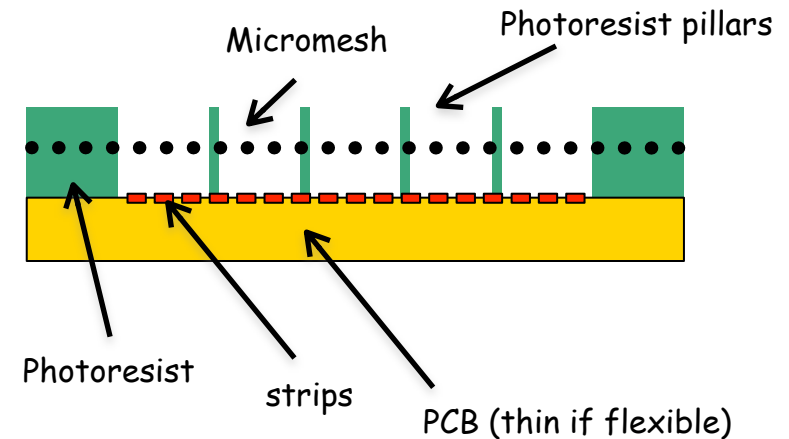
Gas Electron Multiplier

Micromegas **Barrel** Tracking System - EIC R&D

□ Motivation

- **Bulk technology** for MICROMEGAS production:
Lamination of PCB with photo-resist film
- Array of spacers ('pillars') support mesh at constant distance to readout plane
- **Large area production** possible
- **Complement micro-vertex SI detector** at **larger radii**
- **Cost effective solution** for larger radii region
- **Low dead material** ($\sim 0.3\% X_0$)
- **Geometry**: Progress in **cylindrical shape arrangement** - Optimized layout

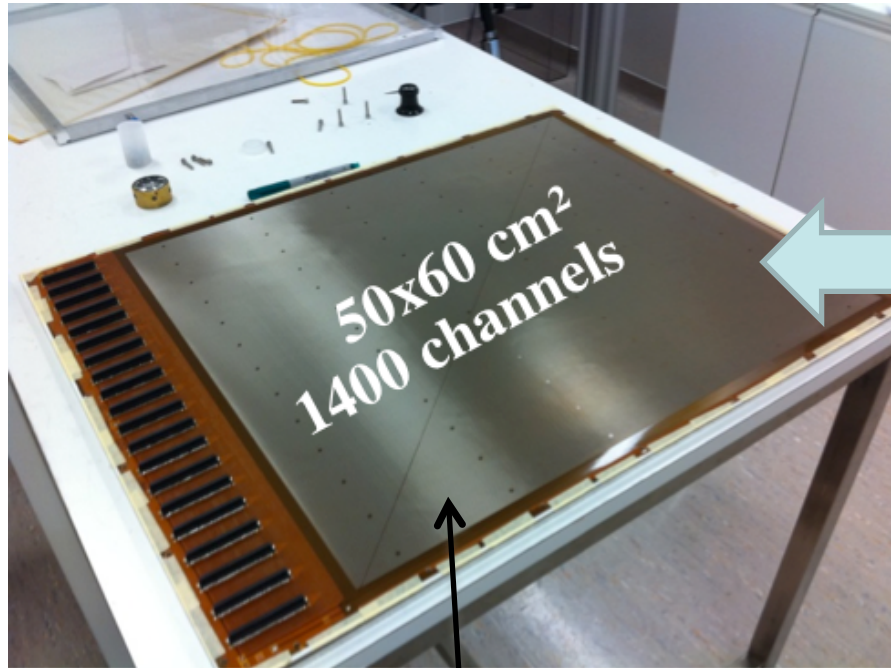
Bulk Technology (mesh imbedded in photoresist)



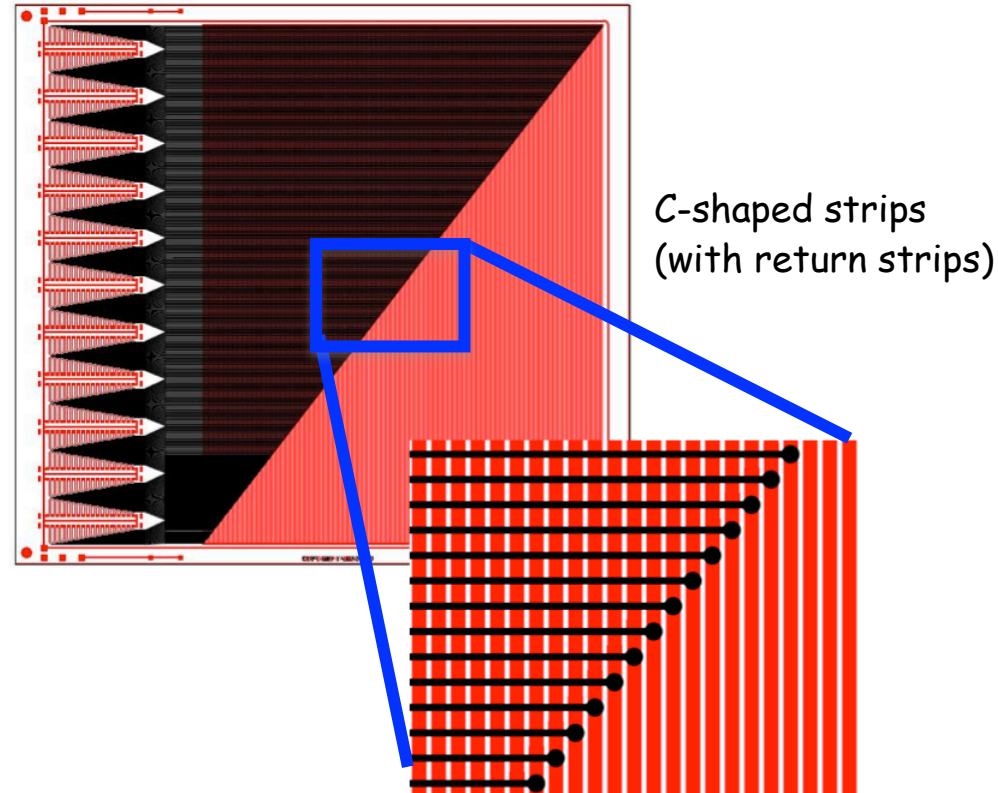
Micromegas Barrel Tracking System - EIC R&D

- Barrel system: CLAS12 Experience (1)

CLAS12



Largest
flexible MM
ever built



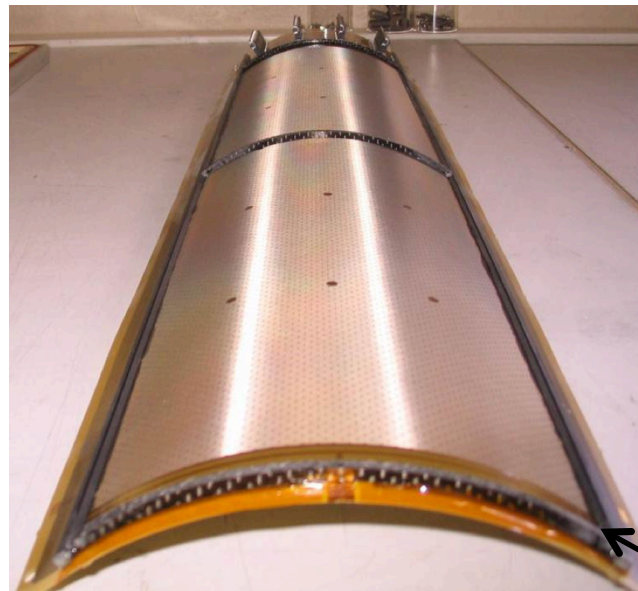
Micromegas Barrel Tracking System - EIC R&D

□ Barrel system: CLAS12 Experience (2)

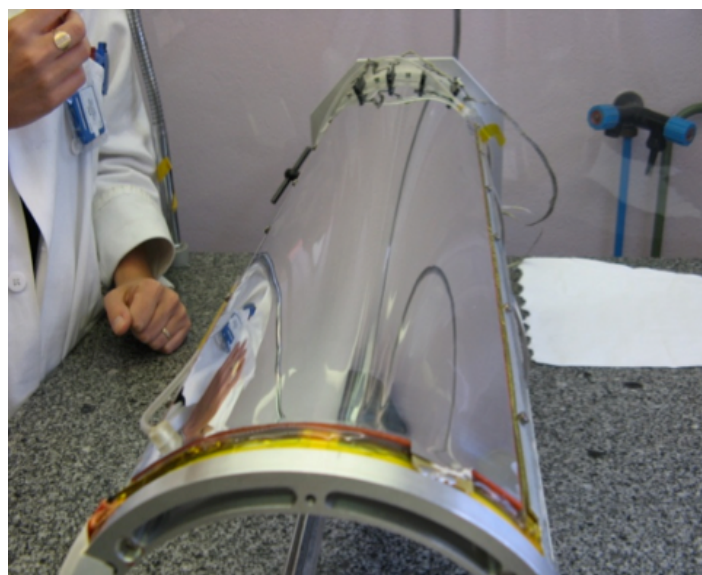
CLAS12 (Start 2015)

Barrel Vertex Tracker:

- R up to ~25cm, L~45cm
- 30k channels
- Self-supporting tiles
- Low material budget
- 100~200 μm resolution
- Designed for use in 5T
- 1.5m flex cable to FEE



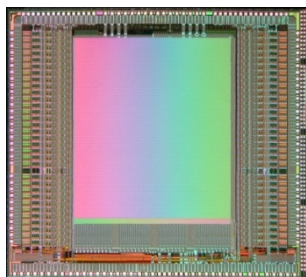
CLAS12



Carbon
Composite
structure

Micromegas Barrel Tracking System - EIC R&D

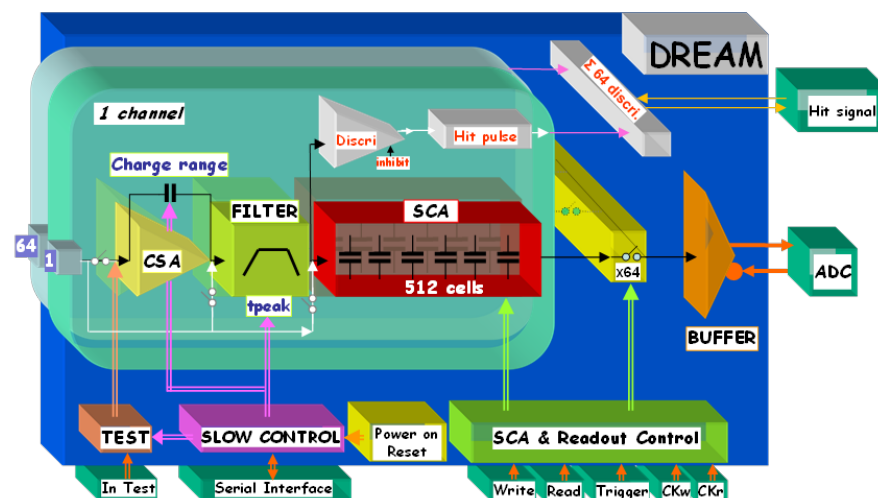
Barrel system: Front-End Electronics



AMS 0.35 μ m, 700.000 transistors

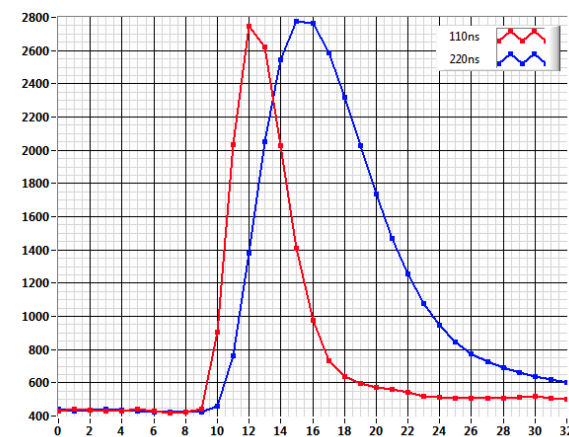


14 mm x 14 mm package



APV-like chip: DREAM (CLAS12 development)

- ☐ 512 cells / channel
- ☐ Low noise
- ☐ Analogue multiplexed output
- ☐ Optimized for large detector capacitance, 50-200pF
- ☐ Latency up to 16 μ s



~25fc Test pulses measured with
DREAM
(110 & 220ns shaping, 50fc range)

Micromegas Barrel Tracking System - EIC R&D

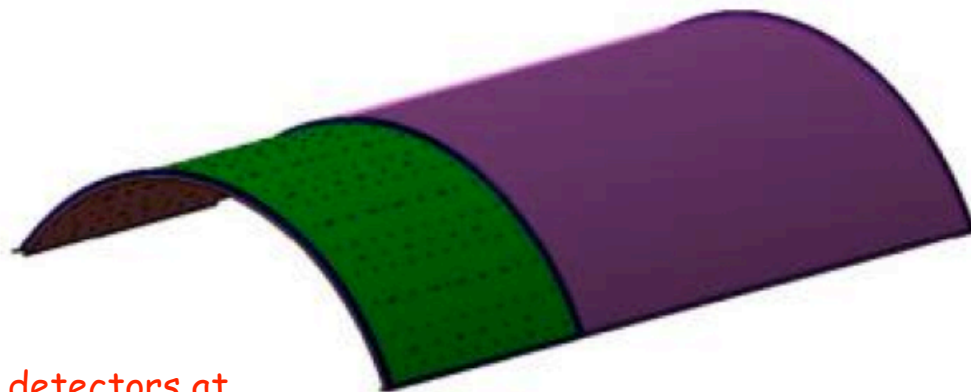
□ Barrel system: R&D

○ Specifications of a new EIC R&D prototype:

- **Dimensions:** $R \sim 50\text{cm}$, $L \sim 100\text{cm}$, $\Delta\phi = 60^\circ$
(x2 wrt CLAS12, needs R&D)
- **Design, production and testing MICROMEGAS detectors at Saclay workshop**
- **Imbedded DREAM electronics**
(with $200\mu\text{m}$ PCB : needs R&D)
or **External readout** with long flex cables
(R&D on very large acceptance detector S/N optimization)
- **Self-trigger capabilities of DREAM**
(R&D on front-end board)

○ Request: 75k\$ (FY12/FY13)

- **Labor:** 50k\$
- **Material** (Prototype with electronics): 25k\$

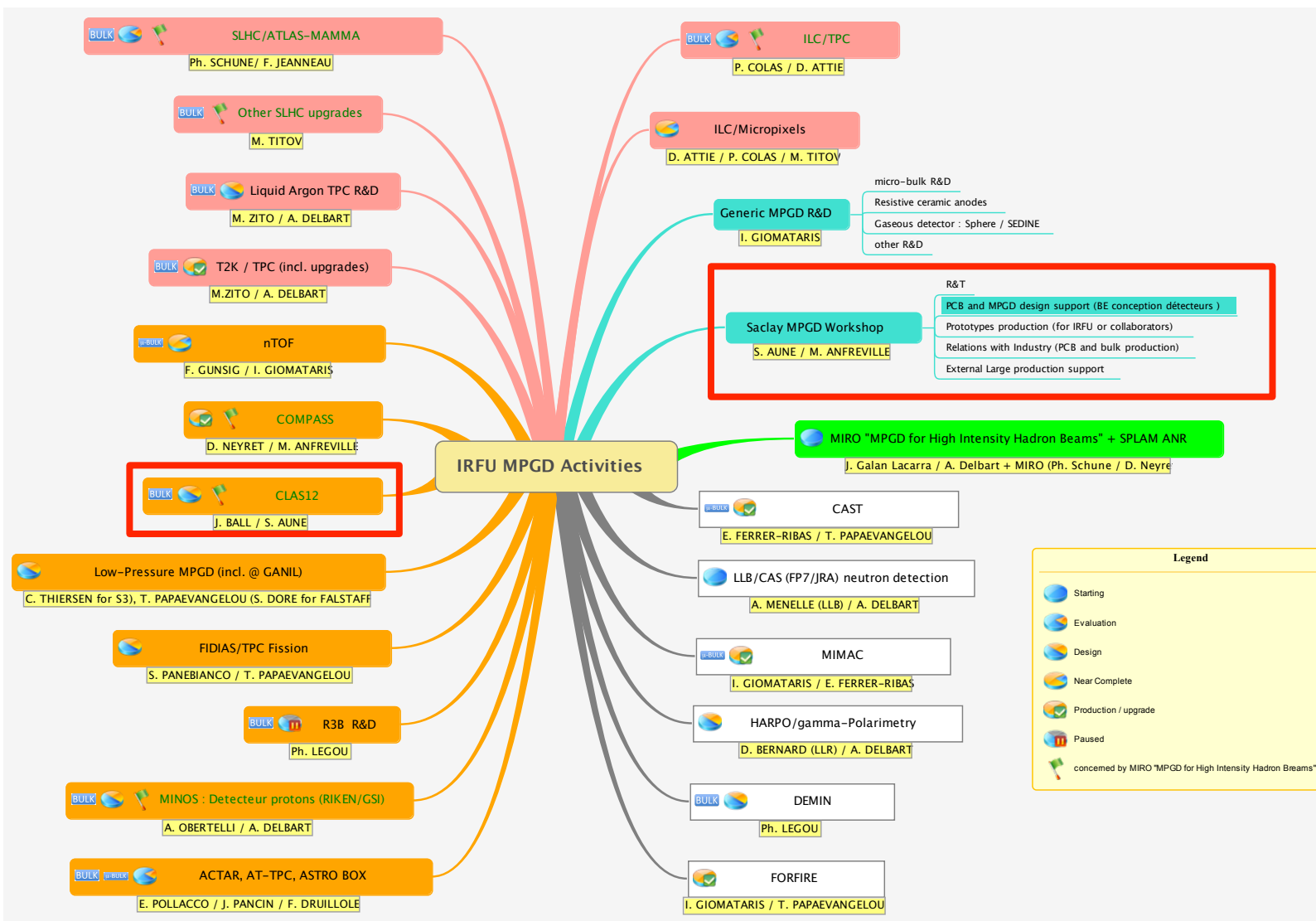


Building a full **prototype segment** essential:

- Mechanics
- Micromegas
- Readout structure
- FEE

Micromegas Barrel Tracking System - EIC R&D

Barrel system: Saclay group experience and resources



Leadership in MPGD technology :

- R&D
- Infrastructure
- Key personnel involved in various world-wide applications
- Key person for EIC prototype production

Triple-GEM **Forward** Tracking System - EIC R&D

□ Motivation

○ Triple-GEM application by various experiments

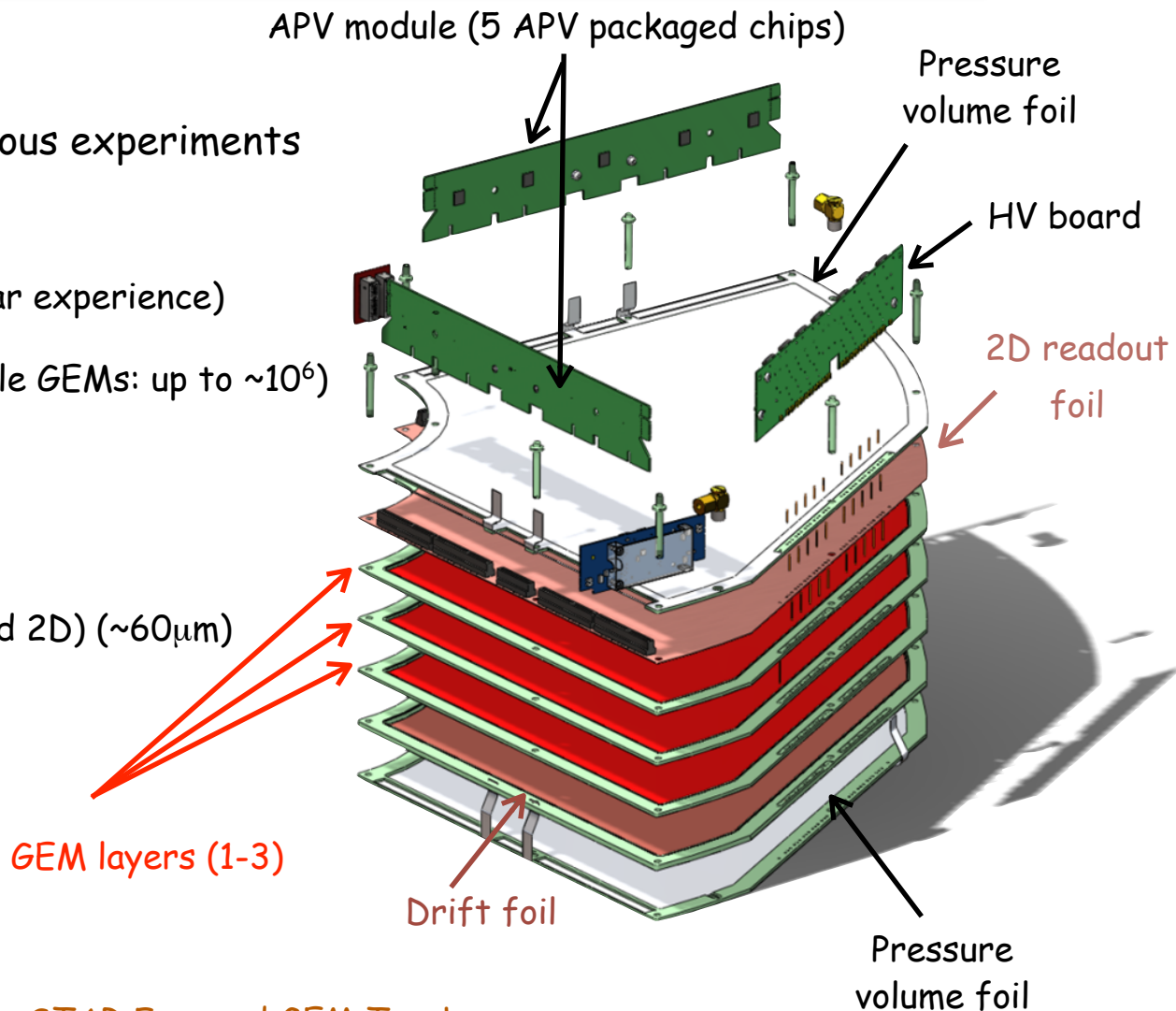
○ Advantages:

- **Reliable** (COMPASS, multi-year experience)
- **High gas amplification** (Multiple GEMs: up to $\sim 10^6$)
- **Fast time response**
- **Low mass** ($< 1\% X_0$)
- **Good spacial resolution** (1D and 2D) ($\sim 60\mu\text{m}$)
- **Relatively low material cost**

F. Sauli, Nucl Instr. and Meth. A386 (1997) 531.

C. Altunbas et al., Nucl Instr. and Meth. A490 (2002) 177.

B. Surrow et al., Nucl Instr. and Meth. A617 (2010) 196.

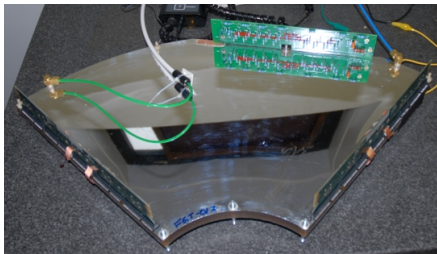


STAR Forward GEM Tracker

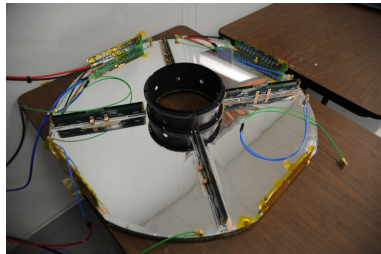
Triple-GEM Detector / Quarter Section
Arrangement

Triple-GEM Forward Tracking System - EIC R&D

□ Forward system: STAR Experience



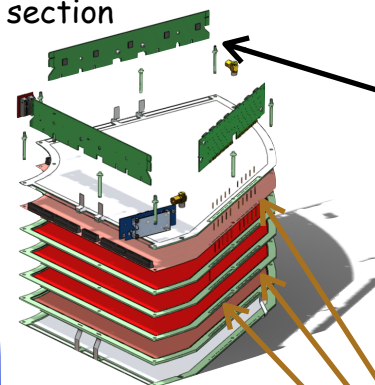
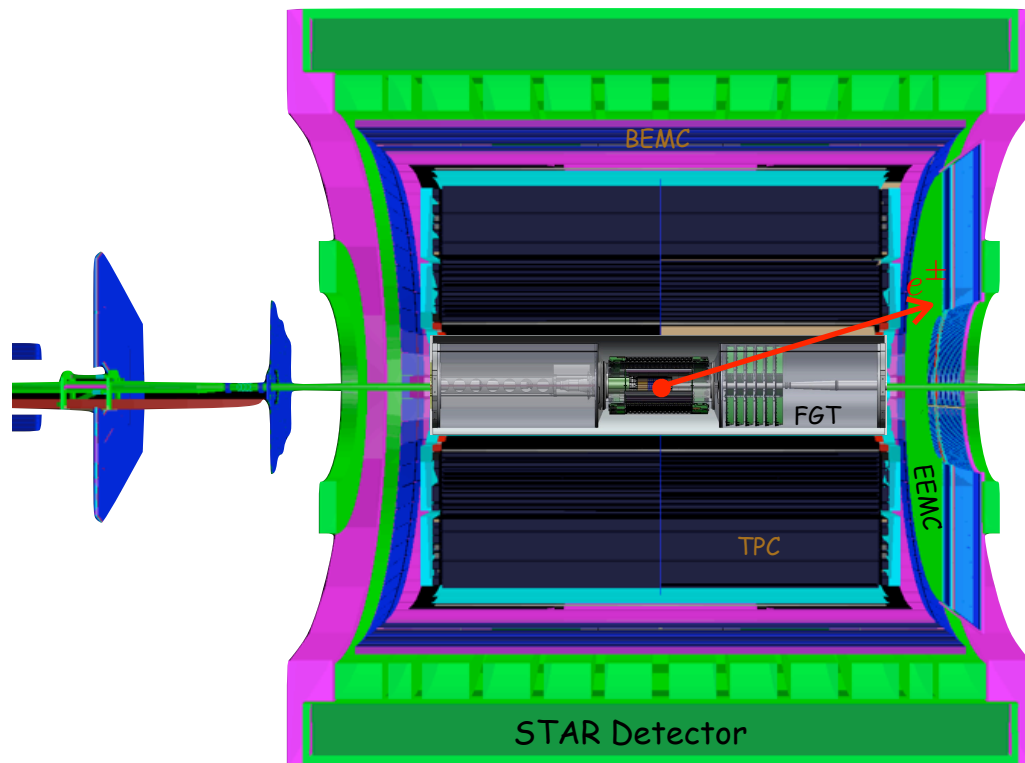
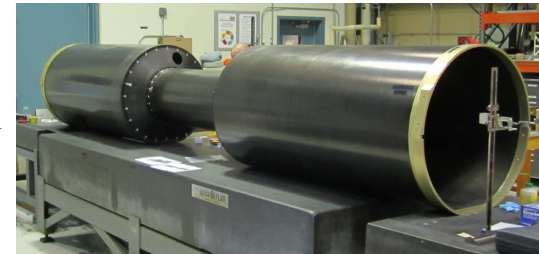
Quarter section



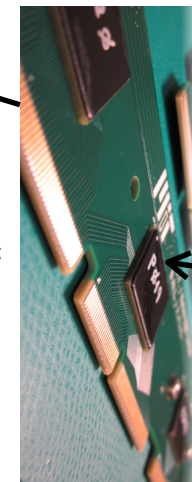
Disk



Quarter section



FGT GEM foil



APV module

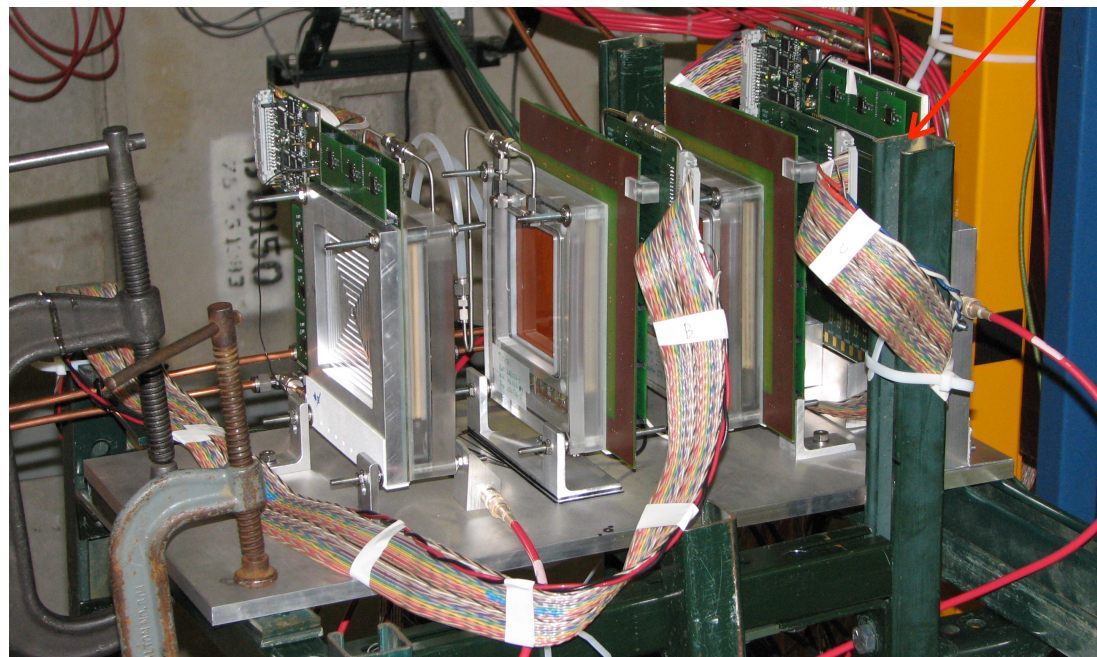
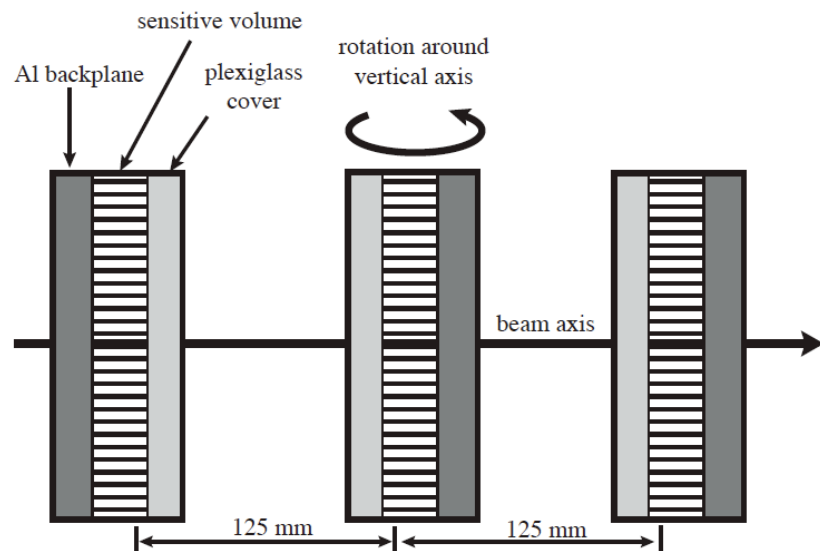
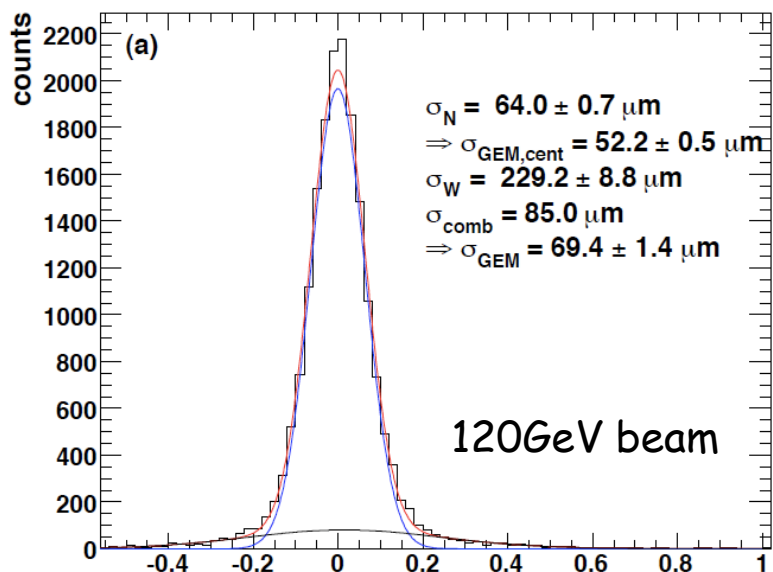
Packaged APV chip



Triple-GEM Forward Tracking System - EIC R&D

Forward system: Commercial fabrication of GEM foils - STAR Experience

APV25-S1

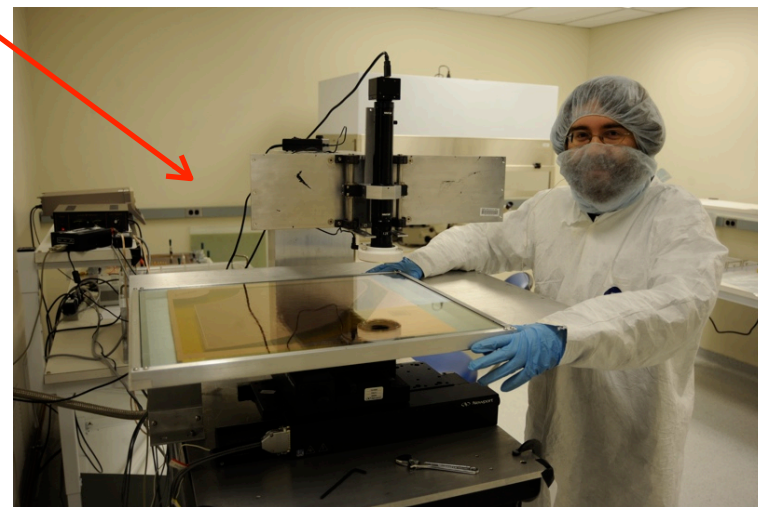
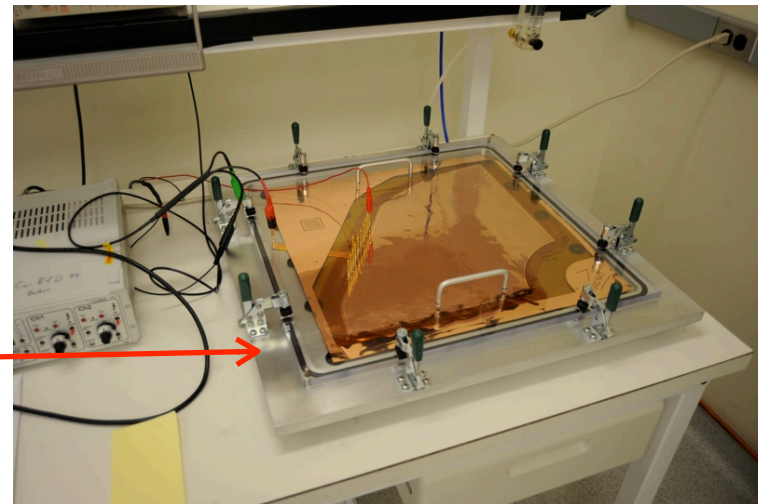


- Extensive R&D program comparing CERN and commercial produced GEM foils by Tech-Etch Inc. (Optical uniformity, source scan of triple-GEM prototypes, test-beam)
- Commercial fabrication of 2D readout board (First generation laser etching by Compunetics Inc. / New: Novel chemical etching technique by Tech-Etch Inc. - foil using VIAS connections)

Triple-GEM **Forward** Tracking System - EIC R&D

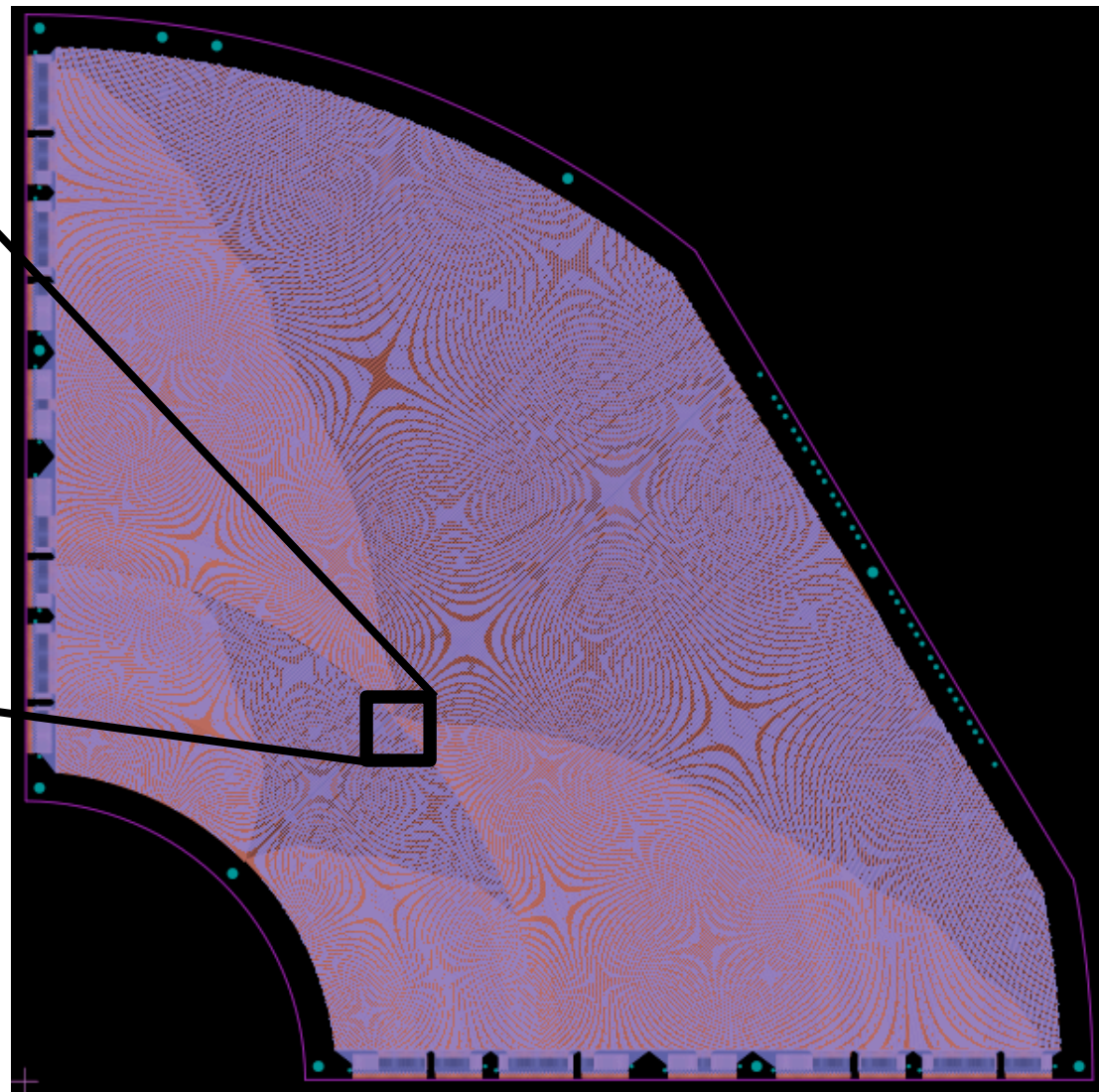
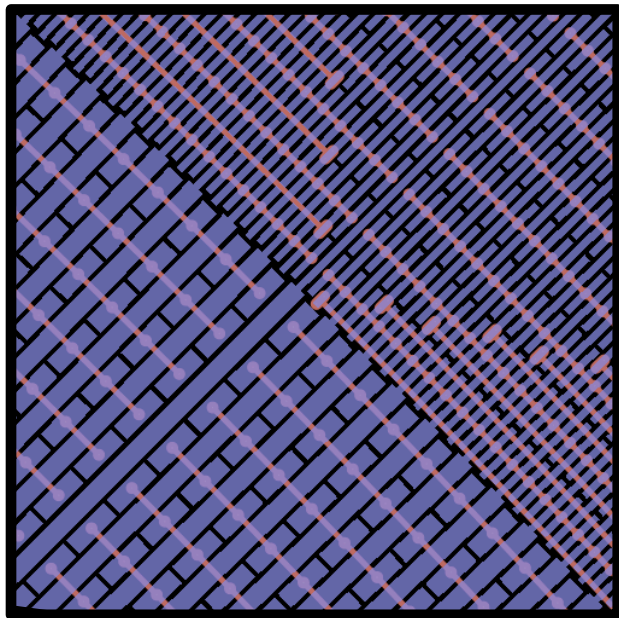
□ Forward system: Large GEM foil development - STAR Experience

- **Extensive R&D program** comparing CERN and commercial produced GEM foils by Tech-Etch Inc. of larger size
- **Leakage current measurements:** Critically depending on cleaning and handling process
- **Optical uniformity measurements:** Tech-Etch Inc. using glass-mask setup - Superior compared to CERN produced double-etching technique foils
- **Next SBIR initiative:** Commercial production of single-masked produced large foils by Tech-Etch Inc. (Long term effort)



Triple-GEM **Forward** Tracking System - EIC R&D

- Forward system: Large 2D readout foil development - STAR Experience



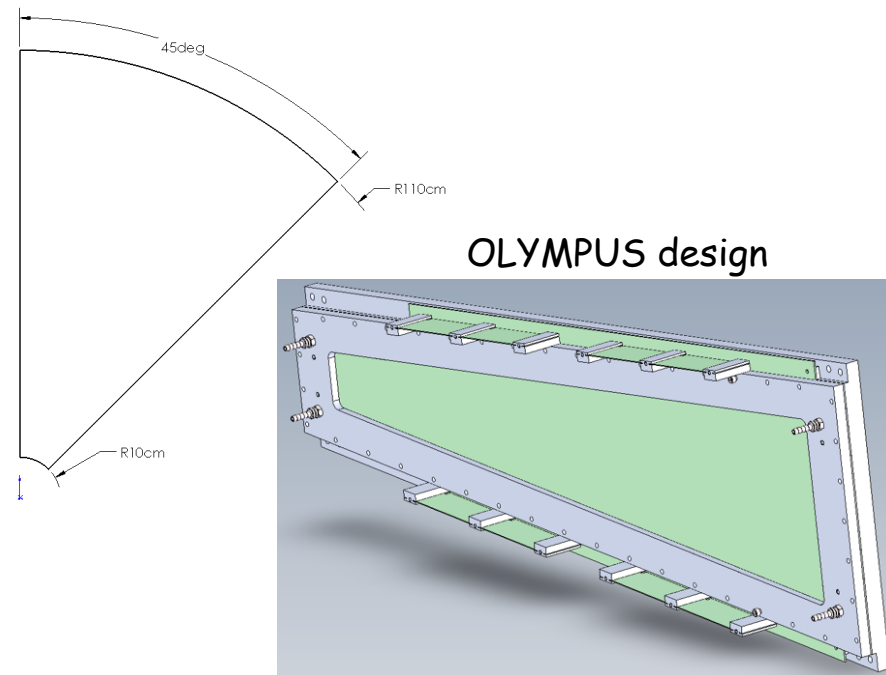
- Commercial fabrication of 2D readout foil -
New: **Novel chemical etching** technique by
Tech-Etch Inc. - **foil using VIAS**
connections)
- Next SBIR initiative: Extension of foil size

Triple-GEM **Forward** Tracking System - EIC R&D

□ Forward system: EIC R&D

○ Specifications of a new EIC R&D prototype:

- **Dimensions:** $R \sim 10\text{cm}$, $L \sim 100\text{cm}$, $\Delta\phi \sim 45^\circ$
(R&D on size limitations and practicality of large foils)
- **Large GEM foil production**
(R&D on size extension - SBIR / First start with CERN single-mask foils)
- **Large 2D readout foil production**
(R&D on size extension - SBIR)
- **Mechanics**
(Frame, support requires R&R)
- Request: 75k\$ (FY12/FY13)
 - **Labor:** 50k\$
 - **Material:** 25k\$



Building a full **prototype segment** essential:

- Mechanics
- Large GEM foils
- 2D readout foils
- FEE and connection

Triple-GEM **Forward** Tracking System - EIC R&D

- Forward system: MIT/Temple group experience and resources
 - **GEM foil production**: Funded SBIR proposal
 - **2D readout board**: Funded SBIR proposal
 - **Mechanical design and assembly** at MIT Bates
 - **FEE design and testing** at MIT Bates
 - **Infrastructure** (R&D Clean Room / Production lab) at MIT Bates
 - **New infrastructure at Temple Univ.**
 - New dedicated detector lab and separate Class 1,000 clean room in new science building
 - Optical CCD camera scan
 - Source scanning setup
 - X-ray source scanning setup
 - **Extensive R&D**
 - GEM foil production (Systematic comparison of CERN and Tech=Etch produced foils)
 - Prototyping (Standard size and large size)
 - Testing (Optical uniformity, Source scan, testbeam)

Collaborative efforts - EIC R&D

□ Examples of existing collaborative efforts

- **SBIR**: BNL, Yale, MIT together with Tech-Etch Inc. (US DOE program)
- **ANR**: French program to commercial certain aspects of MM production (CIREA)
- Selected examples of **collaborative GEM applications**:
 - STAR: FGT (MIT and collaboration institutions) and upgrade
 - OLYMPUS: GEM Tracker (MIT and collaboration institutions)
 - DarkLight: Tracking system (MIT and collaboration institutions)
 - Hall-A (SBS Upgrade): Triple-GEM tracker (UVa: Kondo Gnanvo and Nilanga Liyanage)
 - CMS Upgrade (Myon System): Large foil production (FIT: Marcus Hohlmann, CERN: Archana Sharma)
- Selected examples of **collaborative MICROMEGAS applications**:
 - COMPASS
 - CLAS12
 - T2K
 - SLHC
- **RD51 participation**: Direct collaboration with R. de Oliveira was critical!

Collaborative efforts - EIC R&D

- Saclay / MIT-Temple Univ. R&D research plan and joined funding request
 - Funding request (FY12/FY13): \$150k
 - Labor: \$100k
 - Material: \$50k
 - Research plan focus: FY12/FY13
 - Barrel: Production and testing of large cylindrical MICROMEGAS detectors and chip readout
 - Forward: Mechanical design and production and testing of large GEM foils (Initially CERN foils)
 - Long-term goals:
 - Commercialize large size components
 - Production and testing (Beam test) of full size prototype
 - Essential component: Build and test full size prototype collaborating directly on test equipment, resources incl. man-power and FEE development

Summary

□ Summary

- **Joined proposal** focusing on **micro-pattern technology** concerning one part of tracking system (LOI)
- **Extensive previous experience** and **resources**
- **MICROMEGAS / GEM technology**: Well-suited for EIC application providing a cost-effective solution
- **Intensify collaboration between US / European** institution at various levels
- **Success** replies on adequate support in particular **labor support**
- **Collaboration / communication** with **other R&D efforts** essential on **overall tracking system (LOI)** and **simulations efforts**

